

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
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EPAS ID: PAT5016006

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
BRPHOTONICS PRODUTOS OPTOELETRONICOS S.A.	06/12/2018

**RECEIVING PARTY DATA**

<b>Name:</b>	LIGHTWAVE LOGIC, INC.
<b>Street Address:</b>	369 INVERNESS PKWY
<b>City:</b>	ENGLEWOOD
<b>State/Country:</b>	COLORADO
<b>Postal Code:</b>	80112

**PROPERTY NUMBERS Total: 15**

Property Type	Number
Patent Number:	6716995
Patent Number:	7206490
Patent Number:	6864375
Patent Number:	7019453
Patent Number:	7738745
Patent Number:	7796855
Patent Number:	7888387
Patent Number:	8483524
Patent Number:	7902322
Patent Number:	8442360
Patent Number:	8618241
Patent Number:	8934741
Patent Number:	9535215
Patent Number:	9703128
Patent Number:	9590334

**CORRESPONDENCE DATA**

Fax Number: (206)623-7022

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

Phone: 206-623-7580

**Email:** sepatents@klgates.com  
**Correspondent Name:** K&L GATES LLP  
**Address Line 1:** 925 4TH AVE.  
**Address Line 4:** SEATTLE, WASHINGTON 98104-1158

**NAME OF SUBMITTER:** BRETT O. WHITE

**SIGNATURE:** /Brett O. White/

**DATE SIGNED:** 06/20/2018

**Total Attachments: 3**

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ASSIGNMENT

WHEREAS, the undersigned, BrPhotonics Produtos Optoeletronicos S.A., formerly known as BrPhotonics Produtos Optoeletronicos Ltda., a legal entity incorporated under the laws of the Federative Republic of Brazil, (hereinafter "ASSIGNOR"), is the lawful owner of the issued U.S. patents listed in the attached Exhibit A;

AND WHEREAS, Lightwave Logic, Inc., a Nevada corporation (hereinafter "ASSIGNEE"), and having its principal office and place of business at 369 Inverness Pkwy, Suite 350 Englewood, CO 80112, desires to acquire the entire right, title, and interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, said ASSIGNOR hereby sells, assigns, and transfers to ASSIGNEE and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States, in and to said patents, non-provisional applications, utility applications, divisional applications, continuation applications, continued prosecution applications, continuation-in-part applications, substitute applications, renewal applications, reissue applications, reexaminations, extensions, and all other patent applications that have been or shall be filed in the United States on the inventions defined by said patents and applications listed in Exhibit A; and in and to all original patents, reissued patents, reexamination certificates, and extensions, that have been or shall be issued in the United States on the inventions defined by said patents and applications listed in Exhibit A; and in and to all rights of priority resulting from the filing of the applications leading to said patents;

ASSIGNOR hereby agrees that said ASSIGNOR will generally assist said ASSIGNEE, its successors, assigns, or representatives in vesting title to said patents and applications in said ASSIGNEE, its successors, assigns, and legal representatives; and

ASSIGNOR furthermore covenants with said ASSIGNEE, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

<p><u>ASSIGNOR</u></p> <p>Name: <u>Cristiane Coutinho Silva</u></p> <p>Title: <u>CEO</u></p> <p>Address: <u>1000, De Ricardo Benetton</u> <u>Marinho Street</u></p> <p>Date: <u>June, 12th - 2018</u></p>	<p><u>ASSIGNEE</u></p> <p>Name: _____</p> <p>Title: _____</p> <p>Address: _____</p> <p>Date: _____</p>
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**ASSIGNMENT**

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ASSIGNOR hereby agrees that said ASSIGNOR will generally assist said ASSIGNEE, its successors, assigns, or representatives in vesting title to said patents and applications in said ASSIGNEE, its successors, assigns, and legal representatives; and

ASSIGNOR furthermore covenants with said ASSIGNEE, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

ASSIGNOR

ASSIGNEE



Name: \_\_\_\_\_

Name: James S Marcelli

Title: \_\_\_\_\_

Title: President & COO

Address: \_\_\_\_\_

Address: 369 Inverness Pkwy,

Suite 350

Englewood, CO 80118

Date: \_\_\_\_\_

Date: \_\_\_\_\_

06/12/18

**Exhibit A**

Title	Serial No.	Patent No.
DESIGN AND SYNTHESIS OF ADVANCED NLO MATERIALS FOR ELECTRO-OPTIC APPLICATIONS	09/932,831	US 6,716,995
ELECTRO-OPTIC POLYMER WAVEGUIDE DEVICES INCORPORATING ORGANICALLY MODIFIED SOL-GEL CLADS	10/341,828	US 7,206,490
HIGHLY STABLE AND EFFICIENT NONLINEAR OPTICAL CHROMOPHORES FOR ELECTRO-OPTIC POLYMERS	10/439,621	US 6,864,375
POLYMERS HAVING PENDANT NONLINEAR OPTICAL CHROMOPHORES AND ELECTRO-OPTIC DEVICES THEREFROM	10/625,371	US 7,019,453
METHOD OF BIASING AND OPERATING ELECTRO-OPTIC POLYMER OPTICAL MODULATORS	11/539,397	US 7,738,745
ELECTRO-OPTIC POLYMER DEVICES WITH SEMICONDUCTING OLIGOMER CLADS	11/739,271	US 7,796,855
ELECTRO-OPTIC CHROMOPHORE HAVING AN EDOT STRUCTURE, AND RELATED METHODS AND APPARATUSES	12/110,256	US 7,888,387
INTEGRATED ELECTRO-OPTIC DEVICE AND METHOD OF MAKING	12/246,957	US 8,483,524
NONLINEAR OPTICAL CHROMOPHORES WITH STABILIZING SUBSTITUENT AND ELECTRO-OPTIC DEVICES	12/270,714	US 7,902,322
INTRINSICALLY LOW RESISTIVITY HYBRID SOL-GEL POLYMER CLADS AND ELECTRO-OPTIC DEVICES MADE THEREFROM	12/612,540	US 8,442,360
STABILIZED ELECTRO-OPTIC MATERIALS AND ELECTRO-OPTIC DEVICES MADE THEREFROM	12/959,898	US 8,618,241
INTEGRATED CIRCUIT WITH OPTICAL DATA COMMUNICATION	12/963,479	US 8,934,741
FLUORINATED SOL-GEL LOW REFRACTIVE INDEX HYBRID OPTICAL CLADDING AND ELECTRO-OPTIC DEVICES MADE THEREFROM	13/432,973	US 9,535,215
METHOD FOR MAKING AN INTEGRATED CIRCUIT HAVING OPTICAL DATA COMMUNICATION	14/551,454	US 9,703,128
SOLDERLESS ELECTRICAL INTERCONNECTIONS IN A HIGH SPEED PHOTONIC PACKAGE	15/204,220	US 9,590,334